

SAND2015-4191PE

From coherent to incoherent mismatched interfaces: A generalized continuum formulation of surface stresses

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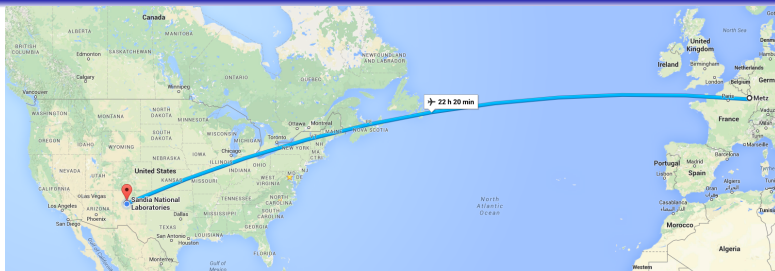
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Where is New Mexico? What is Sandia National Laboratories?



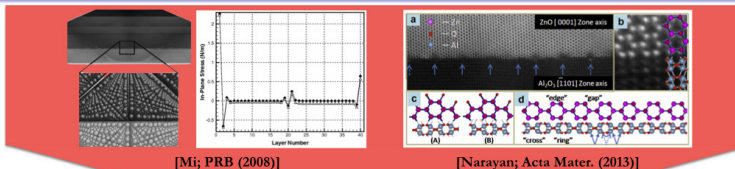
● Sandia National Laboratories in numbers:

- National Security Laboratory created in 1949.
- 6 sites: **Albuquerque (NM)**, Livermore (CA), Calsbad (NM), Amarillo (TX), Tonopah (NV), Kauai (HW).
- 9,200+ employees.

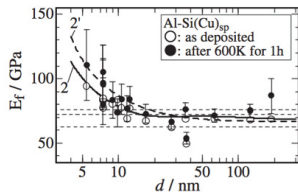
● Nuclear Fuel Cycle Science:

- Sustainable Light Water Reactor Nuclear Energy.
- Advanced Fuel Cycle Technologies.
- **Advanced Modeling and Simulation.**
- Small Modular Reactors.
- Confirmatory Nuclear Experiments.

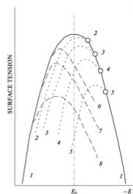
The performance of nanostructures and interfacial systems (i.e. coatings) inherently depends on interfacial properties and interfacial structure.



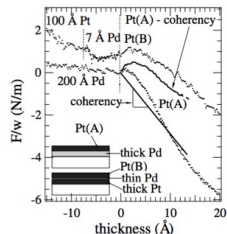
Elasticity



Electrochemistry



Epitaxy



The state of interfacial coherency depends on the physical and the chemical nature between both phases.

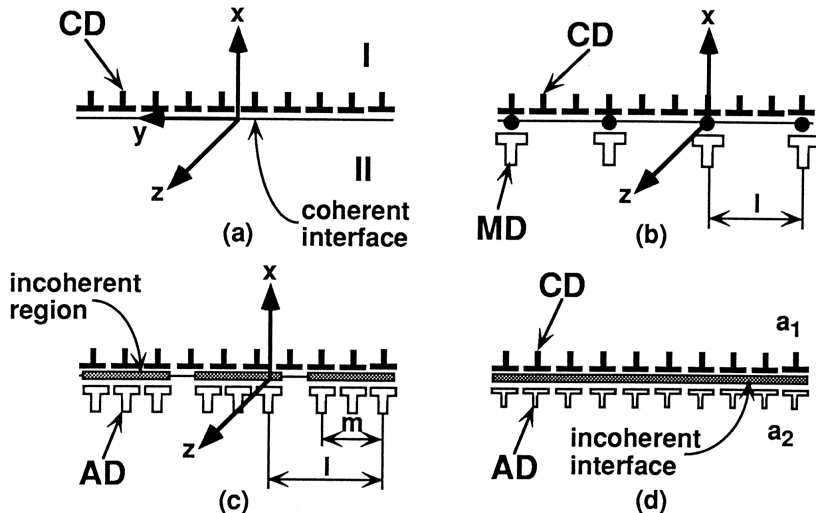
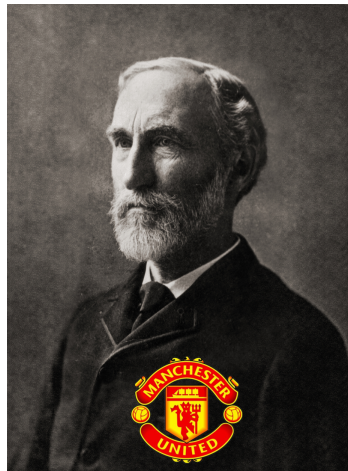


Figure from A.E. Romanov, T. Wagner and M. Rühle; "Coherent to incoherent transition in mismatched interfaces." *Scripta Materialia*, 38(6), pp. 869-875 (1998).

Gibbs? Shuttleworth? Of course the soccer players....
The incoherency in the following (coherent?) story.



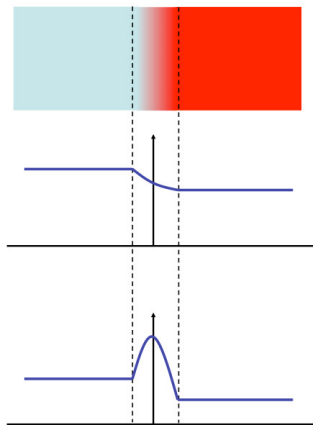
(a) R. Giggs [1990–2014]



(b) J.W. Gibbs [1863–1903]

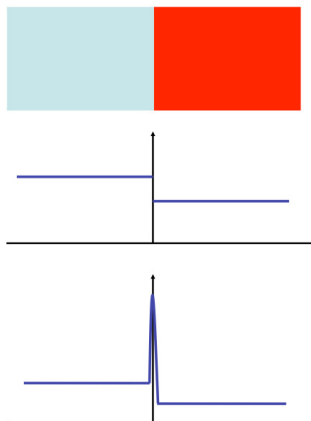
Gibbs (1928) – Dividing surface concept: a 2D mathematical surface of zero thickness over which the thermodynamic properties change discontinuously from one bulk phase to the other.

Interphase model



Dividing surface model

Property



Energy

Gibbs (1928) – Dividing surface concept: a 2D mathematical surface of zero thickness over which the thermodynamic properties change discontinuously from one bulk phase to the other.

Gibbs dividing surface thermodynamic framework:

- **Shuttleworth relation (1950):**

$$\Sigma^S = \Sigma_0^S + \partial\Gamma/\partial\epsilon^S .$$

- **Liquid interface:**

- High atomic mobility.
- Interfacial configuration preserved.
- Surface free energy invariant to deformation loading path: $\partial\Gamma/\partial\epsilon^S = 0$.

- **Solid interface:**

- Long range correlation in atomic positions.
- When solid crystal interfaces deform, their area may change.
- No mass addition, rather **change of surface free energy with deformation**: $\partial\Gamma/\partial\epsilon^S \neq 0$.

Some of the concerns (among many!) when assessing the role of interface in the Gibbsian sense.

- ① **“3D” nature of interface:** Theories based on such two-dimensional framework cannot account for the flexural stiffness.
- ② **Effect of mismatch:** Shuttleworth relation does not account for the interfacial mismatch structure.
- ③ **Coupling effects:** Is there any synergistic effects between loading path and interfacial structure?
- ④ **From a discrete description to a continuum framework:** What is the relationship between the atomistic description of the interface and its thermomechanical description?

Today's reflection and overview:

- 1 **New Mexico?**
- 2 **Where surface matters...**
 - Needs for Gibbs dividing surface thermodynamic framework to account for transverse behavior and interfacial structure.
- 3 **Thermodynamic framework for an incoherent interface**
 - Interfacial kinematics and interfacial kinetics.
 - Generalization of the Shuttleworth relation.
 - Insight on interfacial elasticity.
- 4 **Illustrations for various coherent and incoherent interfaces**
 - Coincidence Site Lattice (CSL) grain boundaries in copper.
 - Incoherent Cu/Cu₂O interfaces.
- 5 **Summary**

Two measures of the Lagrangian interfacial in-plane strain tensors ($\epsilon^S, \epsilon^{*,S}$) are necessary to define the interfacial kinematics.

Coherent surface strain: Measure associated with deforming both phases by the same amount

$$\epsilon^S = \epsilon_+^S = \epsilon_-^S = \frac{1}{2} \left(\nabla^S \mathbf{u}_\pm + \nabla^S \mathbf{u}_\pm^T \right)$$

Medium “+” chosen as our reference phase.

Incoherent surface strain: In-plane eigenstrain related to the change of the interface structure

$$\epsilon^{*,S}(\mathbf{x}) = \epsilon^{0,S} + \epsilon^{m,S} g(\mathbf{x})$$

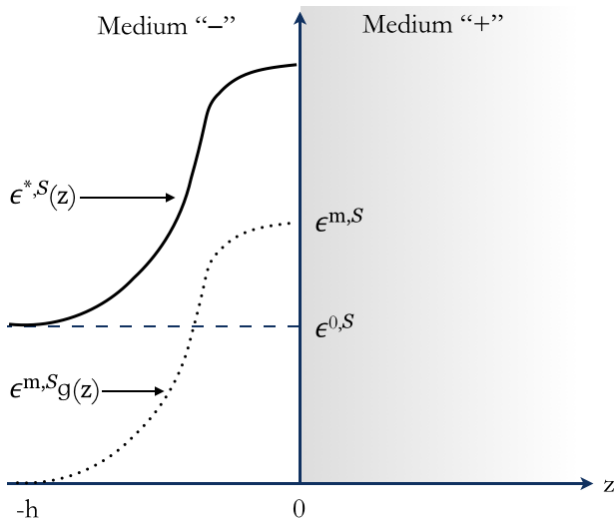
$\epsilon^{0,S}$: change in molar volume between medium “+” and “-”.

$\epsilon^{m,S}$: misfit strain.

Misfit strain and molar volume change eigenstrain

$$\epsilon_{\alpha\beta}^{m,S} = 2 \frac{\lambda_+ - \lambda_-}{\lambda_+ + \lambda_-} \delta_{\alpha\beta}, \quad V_-^0 = \left[1 + \epsilon_{kk}^{0,S} \right]^3 V_+^0 \approx \left[1 + 3\epsilon_{kk}^{0,S} \right] V_+^0$$

Decomposition of the in-plane eigenstrain $\epsilon^{*,S}$ related to the change of the interface structure.



The Gibbs dividing surface thermodynamic framework is used to define the interfacial excess free energy, interfacial excess stress and interfacial excess strain for a coherent and a incoherent interface.

Interfacial thermodynamic framework

$$\Gamma = \hat{\Gamma}(\epsilon^S, \epsilon^{m,S}, \sigma^\perp) = \int_0^\infty (\Psi(\mathbf{x}) - \Psi_+) d\mathbf{x} + \int_{-\infty}^0 (\Psi(\mathbf{x}) - \Psi_-) d\mathbf{x}$$

$$p^{(S)} = \Sigma^S : \dot{\epsilon}^S + \mathbb{D}^\perp \cdot \dot{\sigma}^\perp + \Upsilon^S : \dot{\epsilon}^{m,S}$$

$p^{(S)}$: interfacial power density.

$$\begin{aligned} \Gamma &= \Gamma_0 + \Sigma_0^S : \epsilon^S + \frac{1}{2} \epsilon^S : \underline{\underline{\Gamma}}^{(2)} : \epsilon^S + \frac{1}{2} \sigma^\perp \cdot \underline{\underline{\Lambda}}^{(2)} \cdot \sigma^\perp \\ &+ \Upsilon^{(1)} : \epsilon^{m,S} + \frac{1}{2} \epsilon^{m,S} : \underline{\underline{\Upsilon}}^{(2)} : \epsilon^{m,S} - \epsilon^{m,S} : \underline{\underline{\Phi}} : \epsilon^S \end{aligned}$$

- Interfacial elastic tensors derived using “T-decomposition” ($\epsilon \Rightarrow [\epsilon^S, \epsilon^{*,S}, \sigma^\perp]$) and general anisotropic elasticity with eigenstrains due to lattice mismatch.

Excess thermodynamical quantities are formulated by combining the “T”-decomposition with the Gibbs dividing surface concept.

Interfacial excess stress:

$$\Sigma^S = \int_0^\infty (\sigma^S(\mathbf{x}) - \sigma_+^S) d\mathbf{x} + \int_{-\infty}^0 (\sigma^S(\mathbf{x}) - \sigma_-^S) d\mathbf{x}$$

$$\sigma^S(\mathbf{x}) = \hat{\tau}^S(\mathbf{x}) + \underline{\underline{\mathbb{C}}}^S(\mathbf{x}) : [\epsilon^S(\mathbf{x}) - \epsilon^{*,S}(\mathbf{x})] + \sigma^\perp \cdot \underline{\underline{\gamma}}(\mathbf{x})$$

$$\Sigma^S = \Sigma_0^S - \underline{\underline{\Phi}} : \epsilon^{m,S} + \underline{\underline{\Gamma}}^{(2)} : \epsilon^S + \sigma^\perp \cdot \underline{\underline{\mathbb{H}}}$$

Transverse interfacial excess strain:

$$\Delta^\perp = \int_0^\infty (\epsilon^\perp(\mathbf{x}) - \epsilon_+^\perp) d\mathbf{x} + \int_{-\infty}^0 (\epsilon^\perp(\mathbf{x}) - \epsilon_-^\perp) d\mathbf{x}$$

$$\epsilon^\perp(\mathbf{x}) = \epsilon^{*,\perp}(\mathbf{x}) - \mathbb{M}^\perp(\mathbf{x}) \cdot \tau^\perp(\mathbf{x}) + \mathbb{M}^\perp(\mathbf{x}) \cdot \sigma^\perp - \underline{\underline{\gamma}}(\mathbf{x}) : [\epsilon^S(\mathbf{x}) - \epsilon^{*,S}(\mathbf{x})]$$

$$\Delta^\perp = \Lambda_0^\perp + \underline{\underline{\mathbb{K}}} : \epsilon^{m,S} + \Lambda^{(2)} \cdot \sigma^\perp - \underline{\underline{\mathbb{H}}} : \epsilon^S$$

Generalized Shuttleworth relationships define the connection between the interface thermodynamic quantities and the interface structure.

Generalized Shuttleworth relationship

$$\Sigma^S = \left. \frac{\partial \Gamma}{\partial \epsilon^S} \right|_{\epsilon^{m,S}, \sigma^\perp} + \sigma^\perp \cdot \underline{\underline{\mathbb{H}}}$$

$$\Upsilon^S = \left. \frac{\partial \Gamma}{\partial \epsilon^{m,S}} \right|_{\epsilon^S, \sigma^\perp} - \sigma^\perp \cdot \underline{\underline{\mathbb{K}}} + \underline{\underline{\Phi}} : \epsilon^S$$

$$\mathbb{D}^\perp = \Delta^\perp - \Lambda_0^\perp = \left. \frac{\partial \Gamma}{\partial \sigma^\perp} \right|_{\epsilon^S, \epsilon^{m,S}} - \underline{\underline{\mathbb{H}}} : \epsilon^S + \underline{\underline{\mathbb{K}}} : \epsilon^{m,S}$$

Σ^S : coherent interfacial stress.

Υ^S : incoherent interfacial stress.

\mathbb{D}^\perp : interfacial transverse strain.

Physical interpretation:

Σ^S and Δ^\perp : Thermodynamic driving forces deforming the interface.

Υ^S : Work of stretching one crystal holding the other fixed i.e. altering the structure of the interface.

Deforming a coherent or a incoherent interface does not always increase its interfacial excess energy.

Interfacial thermo-elastic properties

$$\epsilon_{\alpha\beta}^{m,S} = \alpha^S \delta_{\alpha\beta} \Delta T ; \epsilon_{\alpha\beta}^{0,S} = (\alpha_- - \alpha_+) \delta_{\alpha\beta} \Delta T$$

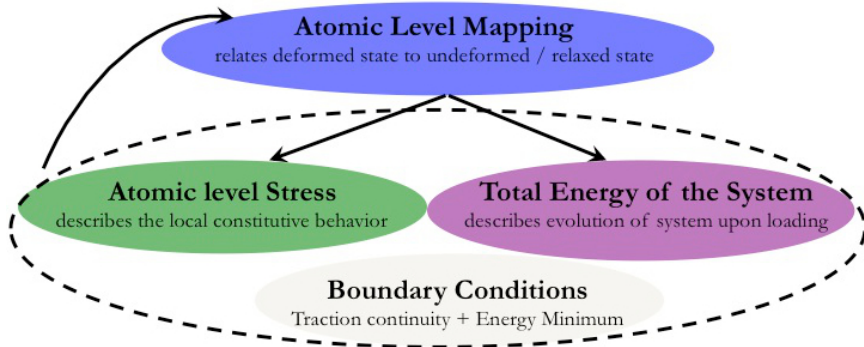
Loading space $(\epsilon^S, \sigma^\perp, \Delta T)$ for which the coherent surface stress Σ^S and the interfacial excess strain Δ^\perp vanish:

$$\begin{bmatrix} \frac{\Gamma_{11}^{(1)}}{2} \\ \Lambda_3^{(1)} \end{bmatrix} + \begin{bmatrix} 2K^S & \frac{2K^S \nu^S}{E^\perp} & -d_0^* \\ -\frac{4K^S \nu^S}{E^\perp} & \frac{1}{E^{*,\perp}} & \frac{2d_0^{*,S}}{E^{*,\perp}} \end{bmatrix} \cdot \begin{bmatrix} \epsilon^S \\ \sigma^\perp \\ \Delta T \end{bmatrix} = \begin{bmatrix} 0 \\ 0 \end{bmatrix}$$

Thermo-mechanical structural connection: $d_0^* = 2K^{*,S} \alpha^S$.

- One can construct a loading path $(\epsilon^S, \sigma^\perp)$ that would minimize the impact of the interface on the behavior of a material system separated by it or construct a loading path for which the surface to volume ratio is significant

A semi-analytical method to estimate interface elastic properties.



Let's perform a Gedanken(atomistic)experiment requiring solely the relaxed configuration of the interfacial system. No load is applied!

Atomic level strain: Measure interfacial deformation under homogeneous deformation (T-decomposition) with internal relaxation

$$r_i^{mn} - \hat{r}_i^{mn} = \left(A_{ij\alpha\beta}^{\pm} \epsilon_{\alpha\beta}^S + B_{ijk}^{\pm} \sigma_k^{\perp} \right) \hat{r}_j^{mn} + (\tilde{\epsilon}_{ij}^m \hat{r}_j^m - \tilde{\epsilon}_{ij}^n \hat{r}_j^n)$$

Virial stress: Based on the assumption that the definition of stress would be valid for a small volume Ω_n around and atom n

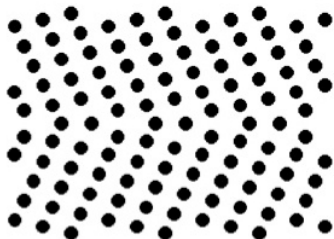
$$\sigma_{ij}^n = \tau_{ij}^n + \mathbb{C}_{ij\alpha\beta}^{S,n} \epsilon_{\alpha\beta}^S + \mathbb{M}_{ijk}^{\perp,n} \sigma_k^{\perp} + \sum_{m=1}^N \mathbb{T}_{ijkl}^{mn} \tilde{\epsilon}_{kl}^m$$

Solve for the internal relaxation

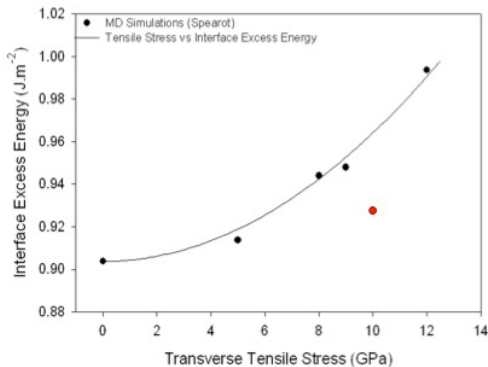
- Traction continuity: $\sigma_i^{\perp,n} = \sigma_i^{\perp}$
- Internal relaxation minimize the total energy of the interfacial system:

$$\frac{\partial W}{\partial \tilde{\epsilon}_{\alpha\beta}^{S,n}}$$

Example: low CSL copper grain boundaries

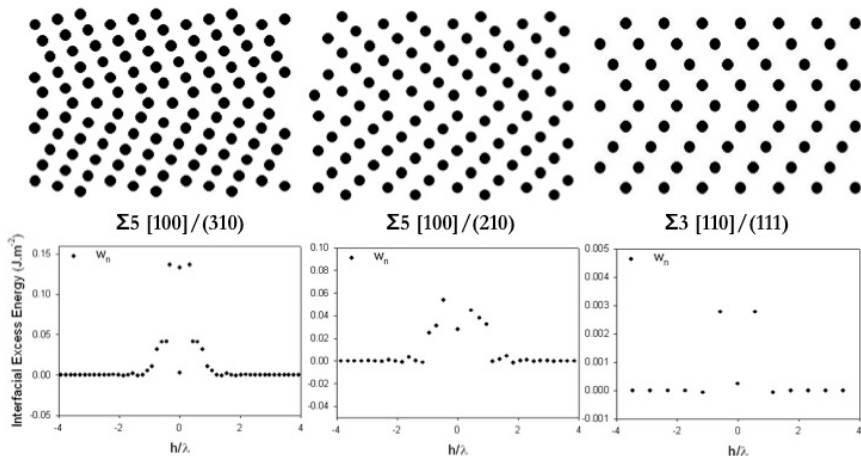


$\Sigma 5$ [100]/(310)



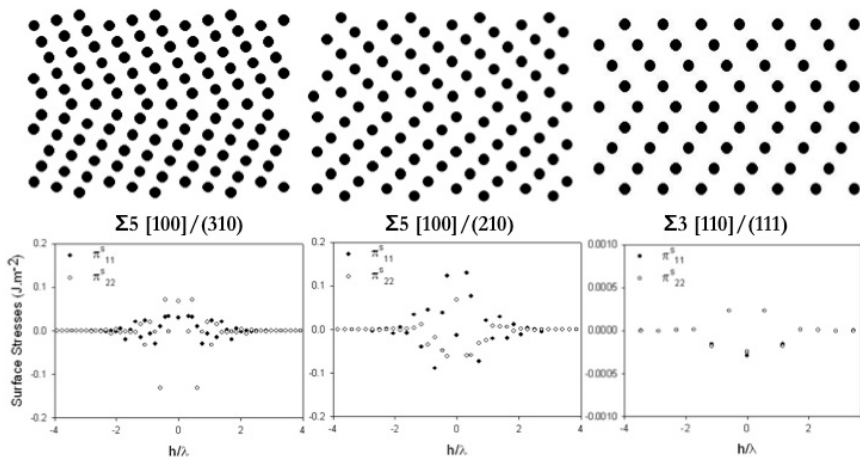
- The methodology provides good correlation with atomistic simulation
- Requires only 1 (Molecular Statics) step
- Reduce in CPU time: no need to apply various load paths
- Full set of interfacial properties in one calculation (including atomistic level moduli)

Inquiring atomistic level elastic properties: Interfacial energy (1/2)



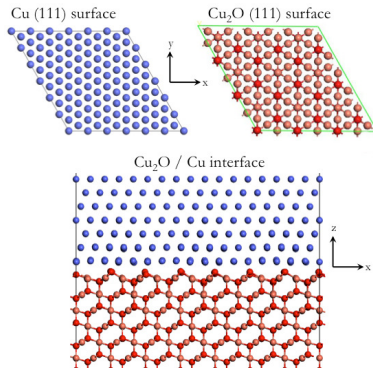
- The loss of translational symmetry over several atomic layers across the interface leads to heterogeneous behavior within the interface “layer”.

Inquiring atomistic level elastic properties: Surface stresses (2/2)



- The loss of translational symmetry over several atomic layers across the interface leads to heterogeneous behavior within the interface “layer”.

Illustration for incoherent Cu/Cu₂O interfaces



- **Molecular Statics calculations** are performed to compute the interfacial excess energy at equilibrium

- **Interfacial structural mismatch:**

$$\epsilon_{\alpha\beta}^{m,S} = 2 \frac{n\lambda_{\text{Cu}} - m\lambda_{\text{Cu}_2\text{O}}}{n\lambda_{\text{Cu}} + m\lambda_{\text{Cu}_2\text{O}}} \delta_{\alpha\beta}$$

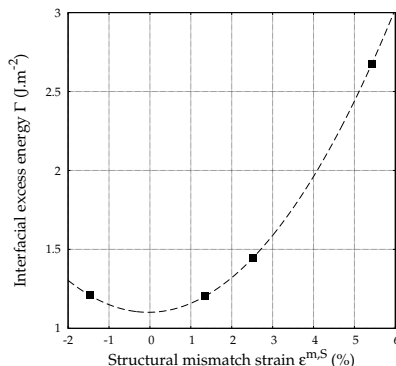
- **Interatomic potential:**

- 1 Cu-Cu: EAM potential [Cleri, 1993].
- 2 Cu-Cu₂O:
 - LJ potential for the interaction between copper metallic atoms and copper atoms from the oxide;
 - Morse potential linking copper metallic atoms with the oxygen atoms [Hallil, 2014].

- **Loading:**

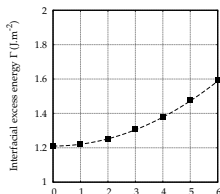
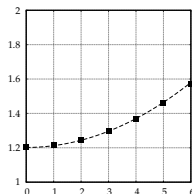
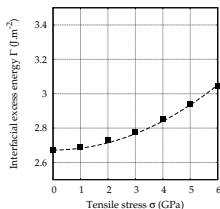
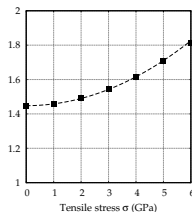
- 1 Biaxial deformation: $\epsilon_{xx}^S = \epsilon_{yy}^S = \epsilon^S$ and $\sigma^\perp = 0$
- 2 Transverse loading: $\sigma^\perp = \sigma_{zz}$ and $\epsilon^S = 0$

Variation of the interfacial excess energy $\Gamma|_{\epsilon^S=0, \sigma^\perp=0}$ (1/3)



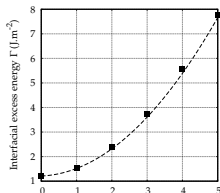
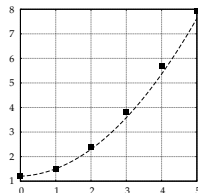
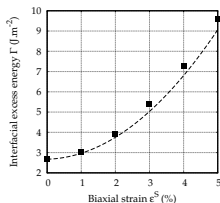
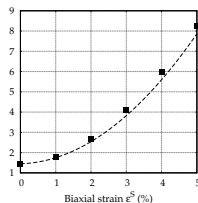
$$\Gamma|_{\epsilon^S=0, \sigma^\perp=0} = \Gamma^* = \Gamma_0 + \Upsilon_{\alpha\alpha}^{(1)} \epsilon_{\alpha\alpha}^{m,S} + \frac{1}{2} \epsilon_{\alpha\alpha}^{m,S} \Upsilon_{\alpha\alpha\beta\beta}^{(3)} \epsilon_{\beta\beta}^{m,S}$$

Variation of the interfacial excess energy $\Gamma|_{\epsilon^S=0}$ (2/3)

(c) $\epsilon^{m,S} = -1.476\%$ (d) $\epsilon^{m,S} = 1.34\%$ (e) $\epsilon^{m,S} = 5.421\%$ (f) $\epsilon^{m,S} = 2.524\%$

$$\Gamma|_{\epsilon^S=0} = \Gamma^* + \frac{1}{2} \sigma^\perp \Lambda_{zz}^{(2)} \sigma^\perp$$

Variation of the interfacial excess energy $\Gamma|_{\sigma^\perp=0}$ (3/3)

(g) $\epsilon^{m,S} = -1.476\%$ (h) $\epsilon^{m,S} = 1.34\%$ (i) $\epsilon^{m,S} = 5.421\%$ (j) $\epsilon^{m,S} = 2.524\%$

$$\Gamma|_{\sigma^\perp=0} = \Gamma^* + \Sigma_{\alpha\alpha}^{S,0} \epsilon_{\alpha\alpha}^S + \frac{1}{2} \epsilon_{\alpha\alpha}^S \Gamma_{\alpha\alpha\beta\beta}^{(2)} \epsilon_{\beta\beta}^S - \epsilon_{\alpha\alpha}^{m,S} \Phi_{\alpha\alpha\beta\beta} \epsilon_{\beta\beta}^S$$

Summary: A generalized continuum formulation of surface stresses for incoherent mismatched interfaces

- **Complete formulation of the thermodynamic framework** relating the coherent surface stress, the incoherent surface stress and the transverse excess strain to the interface excess energy by means of the Gibbs dividing surface concept and “*T-decomposition*” of deformation path.
- Formulation not only **accounts for the three-dimensional nature of the interface in a Gibbsian sense** but also explicitly considers the interfacial structure.
- Origin of surface stresses and their coupling with the interfacial structural mismatch.
- Illustration with examples based on atomistic simulations for incoherent interfaces between Cu and its oxide Cu_2O under various loading configurations.
- Perspective: Equilibrium condition of curved incoherent interfaces and account for interface curvature.